### INTEGRATED CIRCUITS

# DATA SHEET

### **SA57000-XX**

CapFREE™ 150 mA, low-noise, low dropout regulator with thermal protection

Product data
Supersedes data of 2001 Jul 12
File under Integrated Circuits, Standard Analog

2001 Aug 27





### CapFREE™ 150 mA, low-noise, low dropout regulator with thermal protection

**SA57000-XX** 

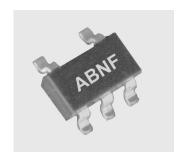
#### **GENERAL DESCRIPTION**

The CapFREE<sup>TM</sup> SA57000 is the first in a new family of unique low dropout regulators. It needs no external capacitors, offers a low output noise voltage of 30  $\mu V_{RMS}$ , and an ultra-low dropout voltage of 55 mV @ 50 mA output current. To accommodate high density layouts, it is packaged in the small footprint 5 leaded SOT23-5 (SO5). It is ideal for all portable and cellular phone applications.

Additional features include power and thermal shutdown, output current limitation, power OK status, thermal warning, and external logic-controlled on-off via the PWRON pin.

#### **FEATURES**

- CapFREE: No output capacitor needed, stable for all capacitive loads, regardless of ESR
- Low 30 μV<sub>RMS</sub> noise without noise bypass capacitor
- Preset output voltages to 2.5 V, 2.8 V, 3.0 V, 3.3 V and 3.6 V; other voltages available upon request. 2% output voltage accuracy
- 150 mA maximum output current with current limitation
- Typical dropout voltage 55 mV @ 50 mA output current
- 85 μA typical ground current
- Thermal-overload and short-circuit protection
- PWROK pin: both power status and thermal warning indicator
- PWRON pin offers logic-controlled shutdown
- Maximum line regulation: 0.1%/V
- Maximum load regulation: 0.02%/mA.



#### **APPLICATIONS**

- Cordless and mobile phones
- Industrial and medical equipment
- Other battery-powered equipment.

#### SIMPLIFIED SYSTEM DIAGRAM

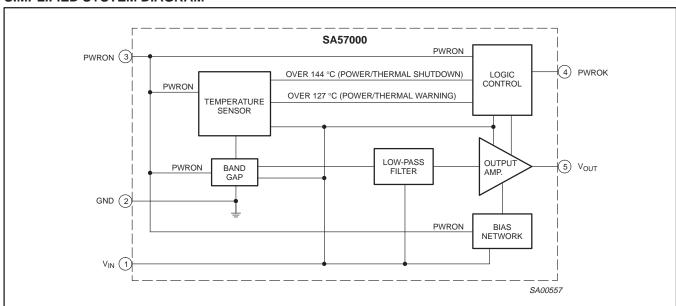


Figure 1. Simplified system diagram.

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#### **ORDERING INFORMATION**

TYPE NUMBER	PACKAGE	PACKAGE					
I THE NUMBER	NAME	AME DESCRIPTION VERSION					
SA57000- <b>XX</b> D	SOT23-5, SOT25, SO5	plastic small outline package; 5 leads (see dimensional drawing)	SOT680-1	–40 to +85 °C			

#### NOTE:

The device has five voltage output options, indicated by the  $\mathbf{X}\mathbf{X}$  on the Type Number.

XX	VOLTAGE (Typical)
25	2.5 V
28	2.8 V
30	3.0 V
33	3.3 V
36	3.6 V

#### Part number marking

Each package is marked with a four letter code. The first three letters designate the product. The fourth letter, represented by 'x', is a date tracking code.

Part number	Marking
SA57000-25D	АВКх
SA57000-28D	ABLx
SA57000-30D	АВМх
SA57000-33D	ABNx
SA57000-36D	АВРх

### **PIN CONFIGURATION**

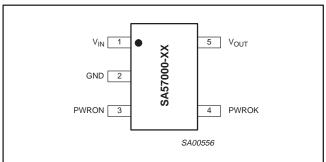


Figure 2. Pin configuration.

#### **PIN DESCRIPTION**

PIN	SYMBOL	DESCRIPTION
1	V <sub>IN</sub>	Regulator input. V <sub>OUT(nom)</sub> + 0.1 V to 5.5 V. No bypass capacitor required.
2	GND	Ground.
3	PWRON	Power-on input. Active-HIGH. A logic LOW powers down regulator. The shutdown quiescent current is typically 50 nA. Connect to V <sub>IN</sub> for manual operation.
4	PWROK	Power OK indicator, including thermal warning. Trips (goes LOW) at 127 °C (±2°), <b>or</b> when power falls typically 6% below V <sub>OUT(nom)</sub> .
5	V <sub>OUT</sub>	Regulator output. Sources up to 150 mA. No bypass capacitors required.

#### **MAXIMUM RATINGS**

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V <sub>IN</sub>	V <sub>IN</sub> to GND voltage	-0.3	5.5	V <sub>dc</sub>
V <sub>PWRON</sub>	PWRON to GND voltage	-0.3	5.5	V <sub>dc</sub>
V <sub>OUT</sub>	OUT to GND voltage	-0.3	V <sub>IN</sub> + 0.3	V <sub>dc</sub>
T <sub>amb</sub>	Operating ambient temperature	-40	+85	°C
Tj	Junction temperature	-	+150	°C
T <sub>stg</sub>	Storage temperature	-65	+160	°C
Р	Power dissipation	-	575	mW
R <sub>th(j-a)</sub>	Thermal resistance from junction to ambient	-	140	°C/W

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#### **CHARACTERISTICS**

 $V_{IN} = V_{OUT(nom)} + 0.5 \text{ V. (Note 1.)}$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>IN</sub>	input voltage		V <sub>OUT(nom)</sub>	-	5.5	V
	output voltage accuracy <sup>2</sup>	I <sub>OUT</sub> = 1 mA				
		$T_{amb} = +25  ^{\circ}C$	_	±1	_	%
		–40 °C ≤ T <sub>amb</sub> ≤ +85 °C	-2.0	-	2.0	%
I <sub>LIM</sub>	current limit		160	300	-	mA
IQ	ground pin current	I <sub>OUT</sub> = 1 mA to 150 mA	-	85	150	μΑ
	dropout voltage 3	I <sub>OUT</sub> = 1 mA	-	1	-	mV
		I <sub>OUT</sub> = 50 mA	_	55	120	mV
		I <sub>OUT</sub> = 150 mA	-	165	-	mV
$\Delta V_{LNR}$	line regulation	$V_{IN} = (V_{OUT} + 0.1 \text{ V}) \text{ to } 5.5 \text{ V}; I_{OUT} = 20 \text{ mA}$	-	-	0.1	%/V
$\Delta V_{LDR}$	load regulation	I <sub>OUT</sub> = 1 mA to 150 mA	-	0.01	0.02	%/mA
e <sub>n</sub>	output voltage noise	f = 10 Hz to 100 kHz, C <sub>OUT</sub> = 10 μF	_	30	_	$\mu V_{RMS}$
Shutdown	•	•			•	
V <sub>IH</sub>	PWRON input threshold (HIGH ON-state)	$V_{IN} \rightarrow V_{OUT(nom)} \rightarrow 5.5 \text{ V}$	$0.7 \times V_{IN}$	-	-	V
V <sub>IL</sub>	PWRON input threshold (HIGH ON-state)	$V_{IN} \rightarrow V_{OUT(nom)} \rightarrow 5.5 \text{ V}$	-	-	$0.3 \times V_{IN}$	V
I <sub>PWRON</sub>	PWRON input bias current	V <sub>PWRON</sub> = V <sub>IN</sub>				
		T <sub>amb</sub> = +25 °C	_	0.01	1	μΑ
		T <sub>amb</sub> = +85 °C	-	0.05	_	μΑ
$I_{Q(SHDN)}$	shutdown supply current	V <sub>OUT</sub> = 0 V				
		T <sub>amb</sub> = +25 °C	_	0.05	1	μΑ
		T <sub>amb</sub> = +85 °C	-	0.2	1	μΑ
t <sub>PWRON</sub>	power-on start-up time <sup>4</sup>	I <sub>OUT</sub> = 1 mA, C <sub>OUT</sub> = 100 nF				
		T <sub>amb</sub> = +25 °C	_	25	100	μs
		$T_{amb} = -40 \text{ to } +85 ^{\circ}\text{C}$	_	35	200	μs
Thermal pr	otection (Note 2)					
T <sub>SHDN</sub>	thermal shut-down temperature		-	144	-	°C
$\Delta T_{SHDN}$	thermal shut-down hysteresis		_	13	_	°C
PWROK ou	tput (power and temperature OK	() (Note 2)				
	PWROK trip temperature		_	127	_	°C
	PWROK trip temperature hysteresis		-	12	_	°C
	PWROK trip as percentage of V <sub>OUT(nom)</sub>		-3.5	-6	-8	%
	PWROK hysteresis as percentage of V <sub>OUT(nom)</sub>		-	2	-	%
	PWROK output (when tripped)	I <sub>SINK</sub> = 0.5 mA	_	0.1	0.4	V

- 1. Limits are production tested at  $T_{amb} = +25 \,^{\circ}\text{C}$ . All devices are 100% production tested at 25  $^{\circ}\text{C}$ . Limits over the operating tempreature are guaranteed by design.

  2. Accuracy ±2 °C over temperature range guaranteed by design and characterization.

  3. The dropout voltage is defined as V<sub>IN</sub> – V<sub>OUT</sub> where V<sub>OUT</sub> is 100 mV below the value of V<sub>OUT</sub> for V<sub>IN</sub> = V<sub>OUT</sub> + 0.5 V..

  4. Time needed for V<sub>OUT</sub> to reach 95% of V<sub>OUT(nom)</sub>.

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#### **TYPCIAL PERFORMANCE CURVES**

Measurements taken with the SA57000-33 (3.3 volt output).

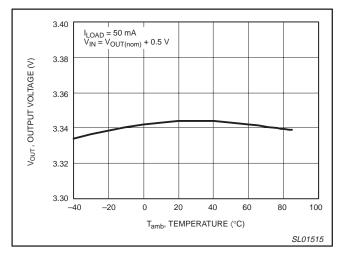


Figure 3. Output voltage versus temperature.

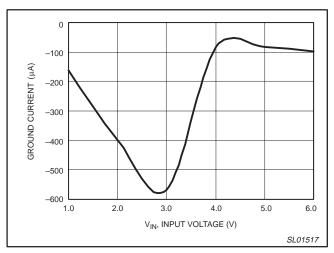


Figure 5. Ground current versus input voltage (no load).

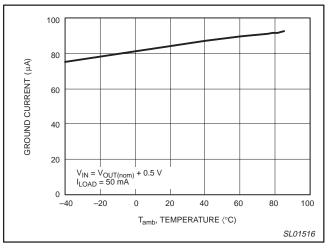


Figure 4. Ground current versus temperature.

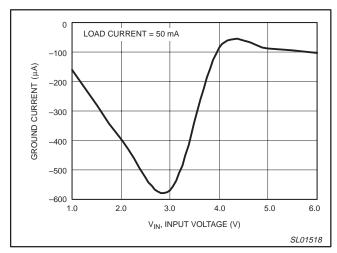


Figure 6. Ground current versus input voltage with load.

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#### **PACKING METHOD**

The SA57000-XX is packed in reels, as shown in Figure 7.

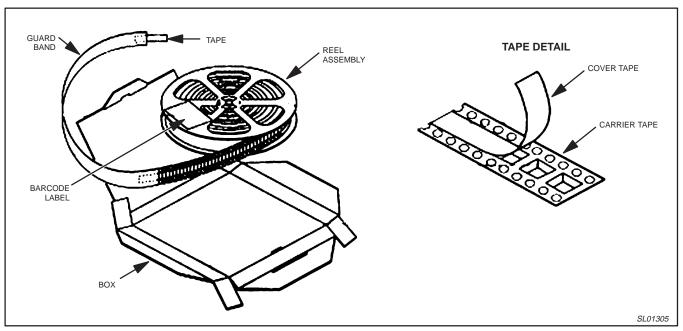
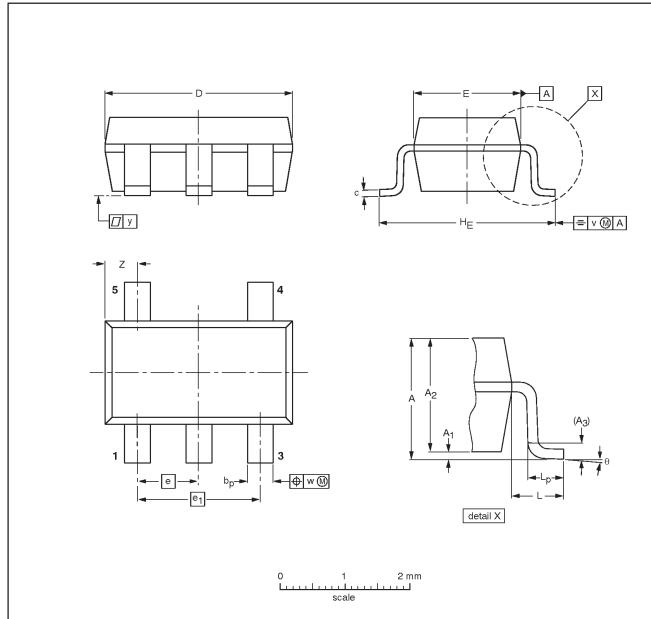


Figure 7. Tape and reel packing method

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### SO5: plastic small outline package; 5 leads; body width 1.6 mm

SOT680-1



#### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	HE	L	Lp	v	w	у	z	θ
mm	1.45	0.05 0.15	1.3 0.9	0.20	0.50 0.30	0.22 0.08	3.05 2.75	1.75 1.45	0.95	1.90	3.00 2.60	0.60	0.60 0.30	0.2	0.2	0.1	0.75 0.25	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT680-1		MO-178				01-03-22

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### CapFREE™ 150 mA, low-noise, low dropout regulator with thermal protection

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#### Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development.  Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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